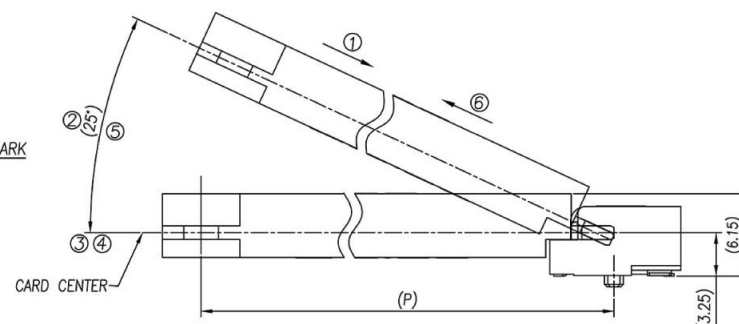
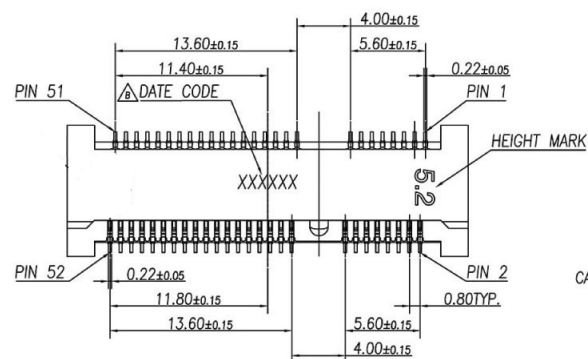
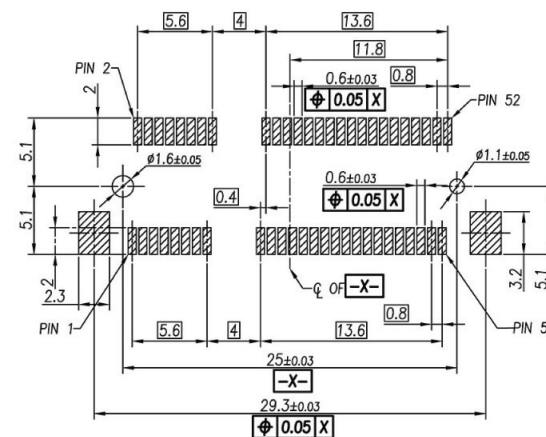
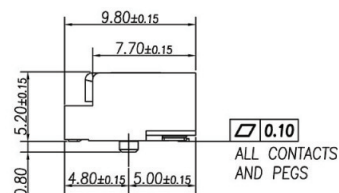
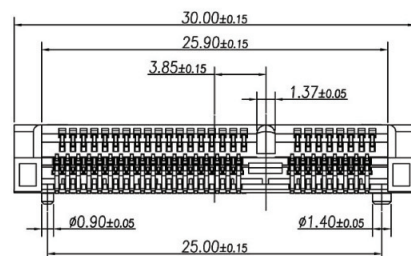




MATING: ① INSERTING(25°) → ② ROTATING → ③ FIXED
UNMATING: ④ UNFIXED → ⑤ ROTATING → ⑥ WITHDRAWING



RECOMMEND PCB LAYOUT (MINIMUM THICKNESS OF THE PCB IS 0.8mm)

(OTHER TOLERANCES ARE NOT MARKED: ± 0.03)

NOTES:

1.MATERIAL:

HOUSING : THERMOPLASTIC , BLACK COLOR ,
FLAME RESISTANCE UL94V-0.

CONTACTS : COPPER ALLOY. THICKNESS 0.20mm.

SOLDER PEGS : COPPER ALLOY. THICKNESS 0.2mm.

2. MSI LEVEL:

$$\text{MSL}(\text{MOISTURE SENSITIVITY LEVELS})=1$$

3.FINISHED:

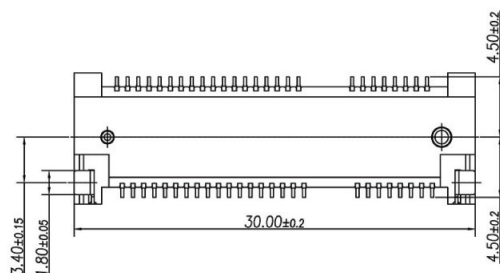
CONTACTS : GOLD PLATING ON CONTACT AREA

50u"~120u" MATTE TIN PLATING ON SOLDER AREA.

30u"~120u" NICKEL UNDER PLATING OVER ALL.

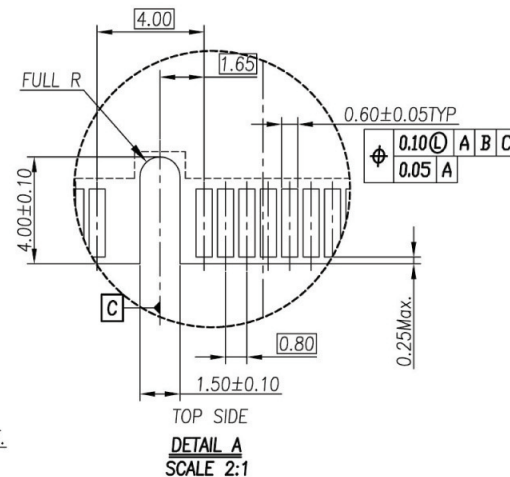
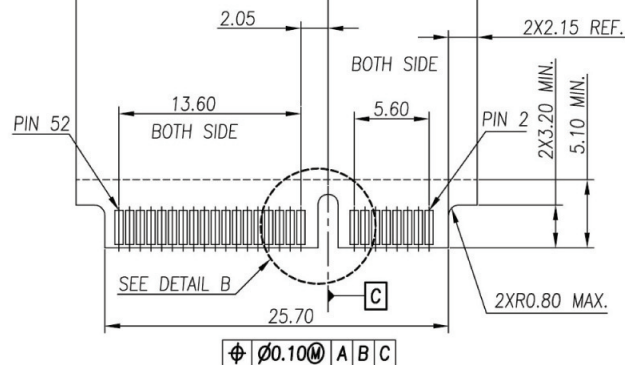
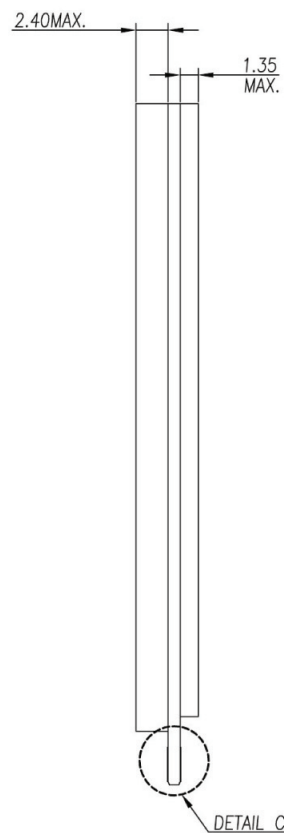
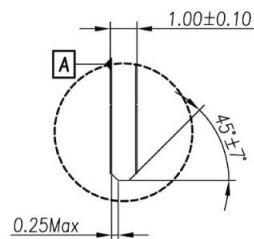
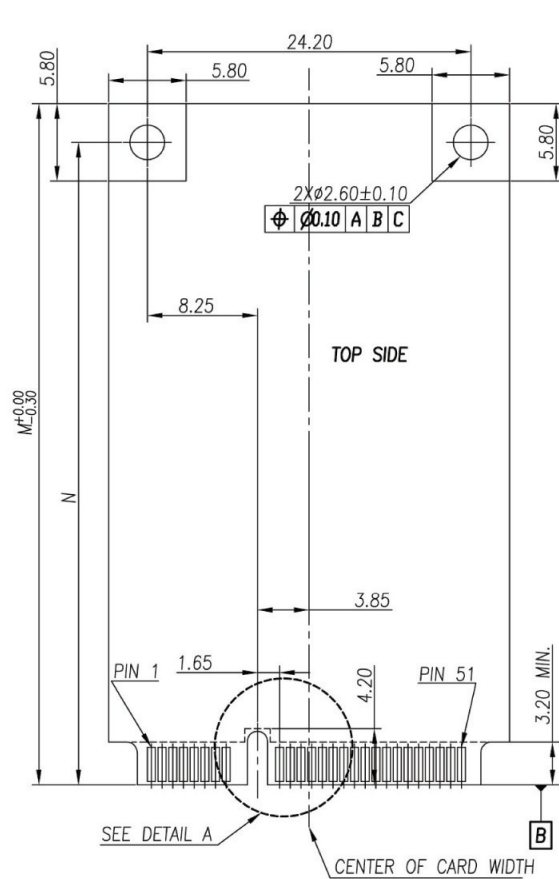
SOLDER PEGS : 50u"~120u" MATTE TIN PLATING OVER ALL.

50u"~120u" NICKEL UNDER PLATING OVER ALL.



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*		DRAWN BY : 陈一鸣		DATE : 2014-02-23		PART NAME: MINI PCI-E 52P 5.2H	
 UNIT: mm [inch]		CHECKED BY: 马跃		DATE : 2014-02-23		PART NO.	HYCW25-PCI52-520B
		APPROVED BY: 邱敏		DATE : 2014-02-23		MOLD NO.	
SCALE:1:1	SIZE: A4			DRAW NO:		HYC-2308011726	
				SHEET NO.		1 OF 1	



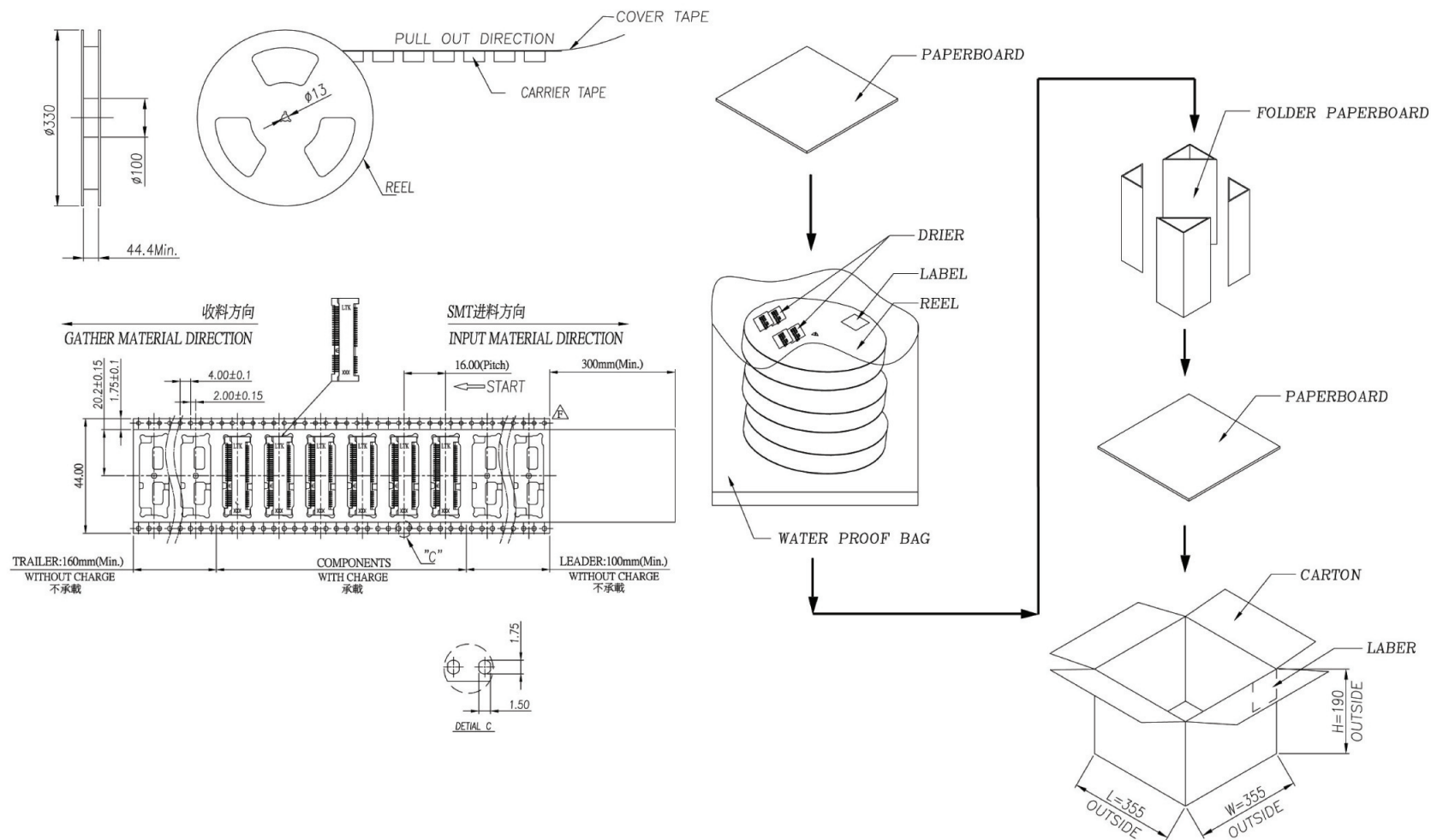
	M	N	P
FULL-MINI CARD	50.95	48.05	48.05
HALF-MINI CARD	26.8	23.9	23.9



深圳市华宇创精密电子有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: MINI PCI 52P 5.2H
CHECKED BY: 马跃	DATE : 2014-02-23	PART NO. HYCW25-PCI52-520B	MOLD NO.
APPROVED BY: 邱敏	DATE : 2014-02-23	DRAW NO: HYC-2308011726	SHEET NO. 1 OF 1

UNIT: mm [inch]
SCALE: 1:1 SIZE: A4



DESCRIPTION	PCS/REEL	REEL/CARTON	PCS/CARTON
MINI PCI 0.8P 52P 5.2H	650	3	1.95K



深圳市华宇创精密电子有限公司

TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X.' ±2" X.X' ±0.5"



UNIT: mm [inch]

SCALE:1:1

SIZE: A4

DRAWN BY :

陈一鸣

DATE :

2014-02-23

PART NAME:

包装图

CHECKED BY:

马跃

DATE :

2014-02-23

PART NO.

MOLD NO.

APPROVED BY:

邱敏

DATE :

2014-02-23

DRAW NO:

SHEET NO.

1 OF 1